



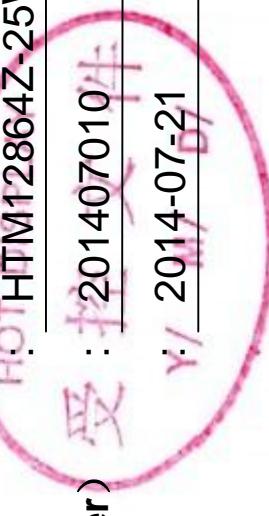
HTM12864Z-25W-A5PP

产品名称 (Product name) : 黑白点阵模组(简体字库)

型 号 (Model) : HTM12864Z-25W-A5P

编 号 (Part number) : 2014070101

日 期 (Date) : 2014-07-21



深圳市鑫洪泰电子科技有限公司

Shenzhen Hot Display Technology Co.,Ltd

Prepared by	Checked by	Approved by	核准

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Rev.	Descriptions	Date
01	Preliminary Release	2014-07-21

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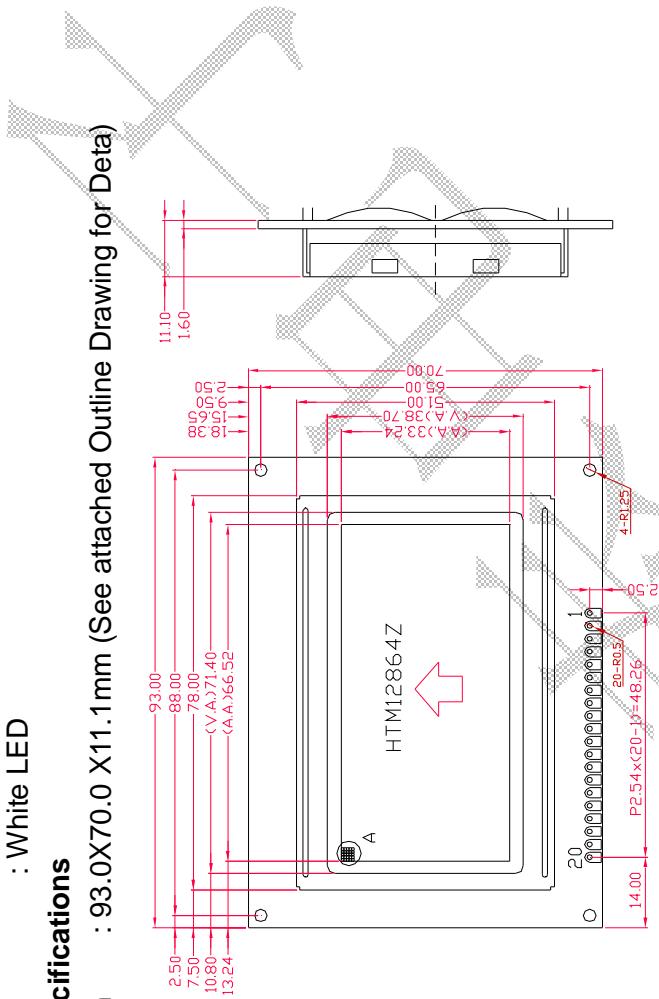
1. Basic Specifications

1.1 Display Specifications

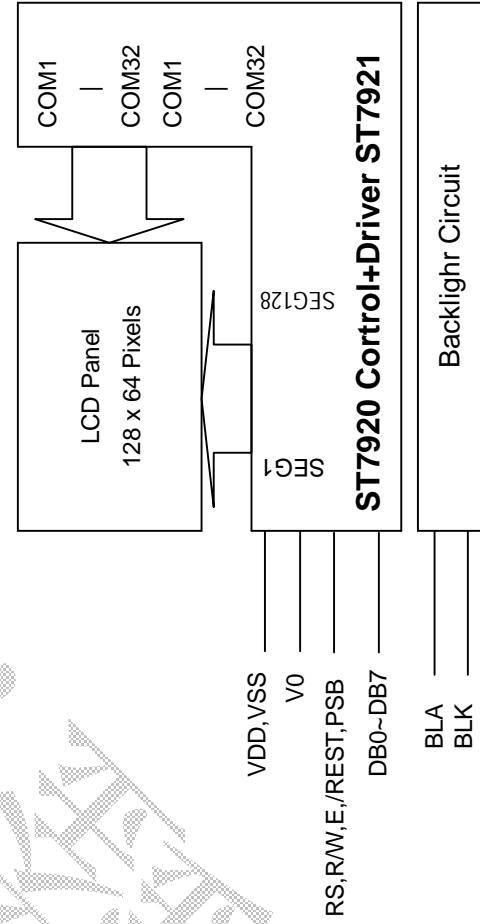
- 1>LCD Display Mode : STN, Negative, Blue, Transmissive
- 2>Viewing Angle : 6H
- 3>Driving Method : 1/33 Duty, 1/5 Bias
- 4 >Backlight : White LED

1.2 Mechanical Specifications

- 1>Outline Dimension : 93.0X70.0 X11.1mm (See attached Outline Drawing for Data)



1.3 Circuit Diagram





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1.4 Terminal Function

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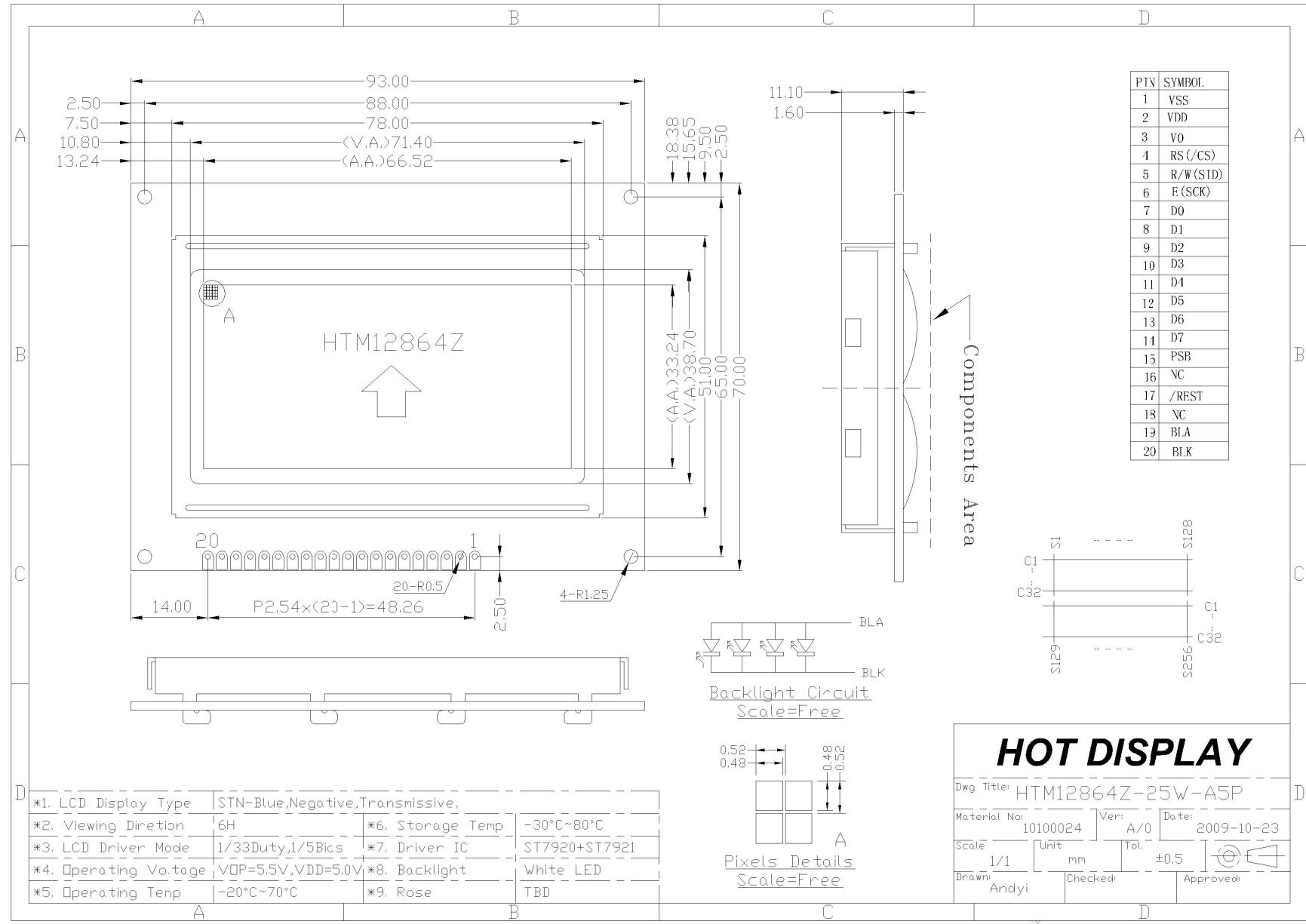
Pin No.	Pin Name	Function
1	VSS	LCD Negative(VSS)
2	VDD	LCD Positive(5.0V)
3	V0	LCD Contrast Adjust
4	RS(CS)	<p>Parallel Mode: Register select. 0: Select instruction register (write) or busy flag, address counter (read); 1: Select data register (write/read).</p> <p>Serial mode: Chip select. 1: chip enabled; 0: chip disabled.</p> <p>When chip is disabled, SID and SCLK should be set as "H" or "L". Transient of SID and SCLK is not allowed.</p>
5	R/W(SID)	<p>Parallel Mode: Read/Write control. 0: Write; 1: Read.</p> <p>Serial Mode: Serial data input.</p>
6	E(SCLK)	<p>Parallel Mode: 1: Enable trigger. Serial Mode: Serial clock.</p>
7~14	D0~D7	Data Buss
15	PSB	<p>Interface selection: 0: serial mode; 1: 8/4-bit parallel bus mode.</p>
16	NC	
17	/REST	System reset input (low active).
18	NC	
19	BLA	Bcklight Positive(5.0V)
20	BLK	Bcklight Negtive(VSS)



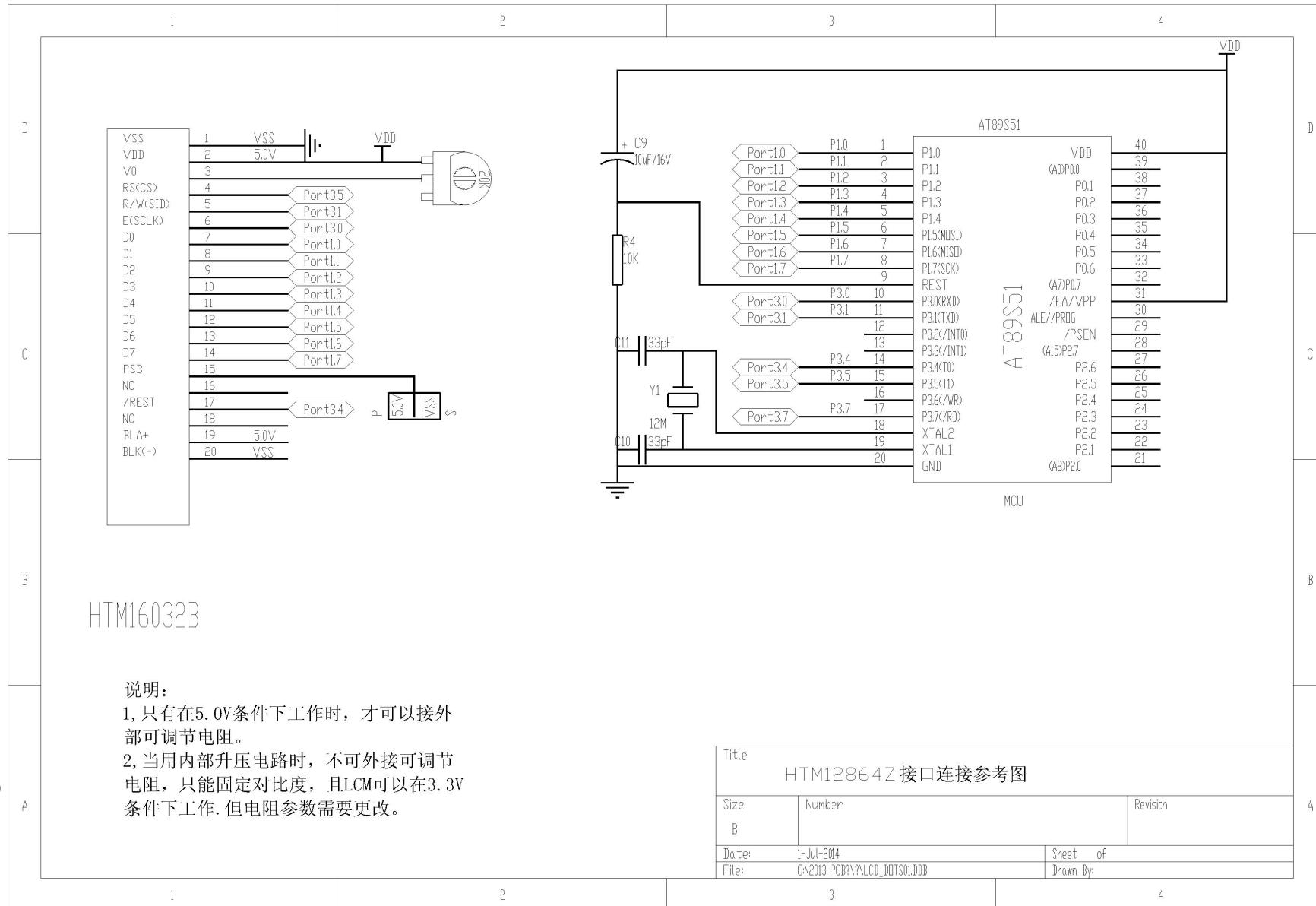
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1.5 Product Outline



1.6 Schematic Diagram



2. Absolute Maximum Ratings

Items	Symbol	MIN.	MAX.	Unit	Condition
Supply Voltage	V _{DD}	3.3	+5.5	V	V _{SS} = 0V
	V _{Lcd}	3.0	+7.0	V	V _{SS} = 0V
Input Voltage	V _{IN}	-0.3	V _{DD} +0.3	V	V _{SS} = 0V
Operating Temperature	T _{OP}	-20	+70	°C	No Condensation
Storage Temperature	T _{st}	-30	+80	°C	No Condensation

3. Electrical Characteristics

3.11 DC Characteristics (TA= 25 °C, VDD=2.7V~4.5V)

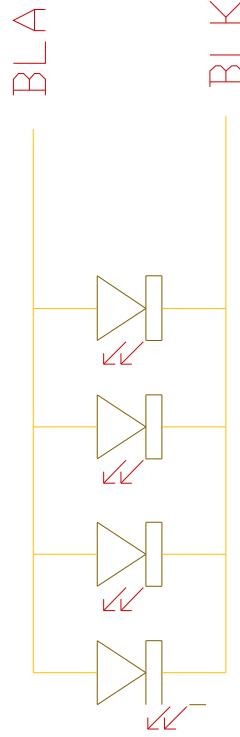
Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
V _{DD}	Operating Voltage	-	2.7	-	5.5	V
V _{LCD}	LCD Voltage	V _{DD} -V _{SS}	3.0	-	7	V
I _{CC}	Power Supply Current	f _{osc} = 530KHz, V _{DD} =3.0V Rf=18KΩ	-	0.20	0.45	mA
V _{in1}	Input High Voltage (Except OSC1)	-	0.7V _{DD}	-	V _{DD}	V
V _{in1}	Input Low Voltage (Except OSC1)	-	-0.3	-	0.6	V
V _{in2}	Input High Voltage (OSC1)	-	V _{DD} -1	-	V _{DD}	V
V _{in2}	Input Low Voltage (OSC1)	-	-	-	1.0	V
V _{oh1}	Output High Voltage (DB0 - DB7)	I _{oh} = -0.1mA	0.8V _{DD}	-	V _{DD}	V
V _{ol1}	Output Low Voltage (DB0 - DB7)	I _{ol} = 0.1mA	-	-	0.1	V
V _{oh2}	Output High Voltage (Except DB0 - DB7)	I _{oh} = -0.04mA	0.8V _{DD}	-	V _{DD}	V
V _{ol2}	Output Low Voltage (Except DB0 - DB7)	I _{ol} = 0.04mA	-	-	0.1V _{DD}	V
I _{leak}	Input Leakage Current	V _{IN} = 0V to V _{DD}	-1	-	1	μA
I _{up}	Pull Up MOS Current	V _{DD} = 3V	22	27	32	μA

3.12 DC Characteristics (TA=25 °C, VDD=4.5V)

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
V _{DD}	Operating Voltage	-	4.5	-	5.5	V
V _{LCD}	LCD Voltage	V ₀ -V _{SS}	3.0	-	7	V
I _{CC}	Power Supply Current	f _{osc} = 540KHz, V _{DD} =5V R _F =33KΩ	-	0.45	0.75	mA
V _{H11}	Input High Voltage (Except OSC1)	-	0.7V _{DD}	-	V _{DD}	V
V _{H11}	Input Low Voltage (Except OSC1)	-	-0.3	-	0.6	V
V _{H12}	Input High Voltage (OSC1)	-	V _{DD} -1	-	V _{DD}	V
V _{H12}	Input Low Voltage (OSC1)	-	-	-	1.0	V
V _{OH1}	Output High Voltage (DB0 - DB7)	I _{O1} = -0.1mA	0.8V _{DD}	-	V _{DD}	V
V _{OL1}	Output Low Voltage (DB0 - DB7)	I _{O1} = 0.1mA	-	-	0.4	V
V _{OH2}	Output High Voltage (Except DB0 - DB7)	I _{O1} = -0.04mA	0.8V _{DD}	-	V _{DD}	V
V _{OL2}	Output Low Voltage (Except DB0 - DB7)	I _{O1} = 0.04mA	-	-	0.1V _{DD}	V
I _{LEAK}	Input Leakage Current	V _{IN} = 0V to V _{DD}	-1	-	1	μA
I _{PUP}	Pull Up MOS Current	V _{DD} = 5V	75	80	85	μA

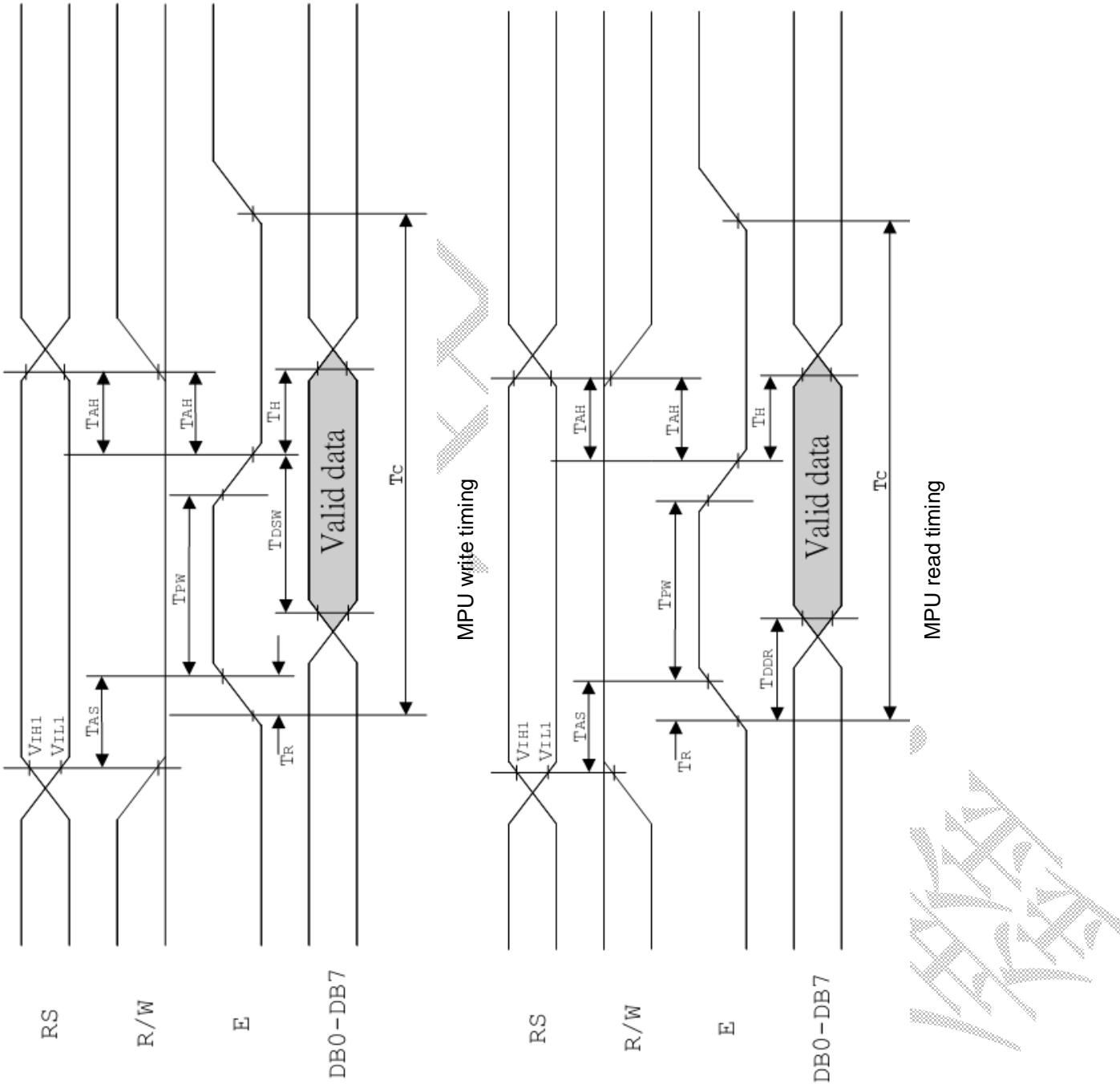
3.2 LED Backlight Circuit

Items	Symbol	MIN.	Typ.	MAX.	Unit	Condition
Forward Voltage	V _{f BLA}	-	3.1	-	V	Without Resistance
Forward Current	I _{f BLA}	-	60	80	mA	-



3.3 AC Characteristics

3.3.1 Parallel Mode Interface





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(TA= 25 °C, VDD= 4.5V)

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<i>Internal Clock Operation</i>						
f_{osc}	OSC Frequency	R = 33KΩ	480	540	600	KHz
<i>External Clock Operation</i>						
f_{ex}	External Frequency	-	480	540	600	KHz
	Duty Cycle	-	45	50	55	%
T_R, T_F	Rise/Fall Time	-	-	0.2	μ s	
<i>Write Mode (Writing data from MPU to ST7920)</i>						
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{pw}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{as}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns
T_{ah}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns
T_{dsw}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns
T_h	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Read Mode (Reading Data from ST7920 to MPU)</i>						
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{pw}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{as}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns
T_{ah}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns
T_{ddr}	Data Delay Time	Pins: DB0 - DB7	-	-	100	ns
T_h	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Interface Mode with LCD Driver(ST7921)</i>						
T_{cwh}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns
T_{cwl}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns
T_{cst}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns
T_{su}	Data Setup Time	Pin: D	300	-	-	ns
T_{dh}	Data Hold Time	Pin: D	300	-	-	ns
T_{dm}	M Delay Time	Pin: M	-1000	-	1000	ns



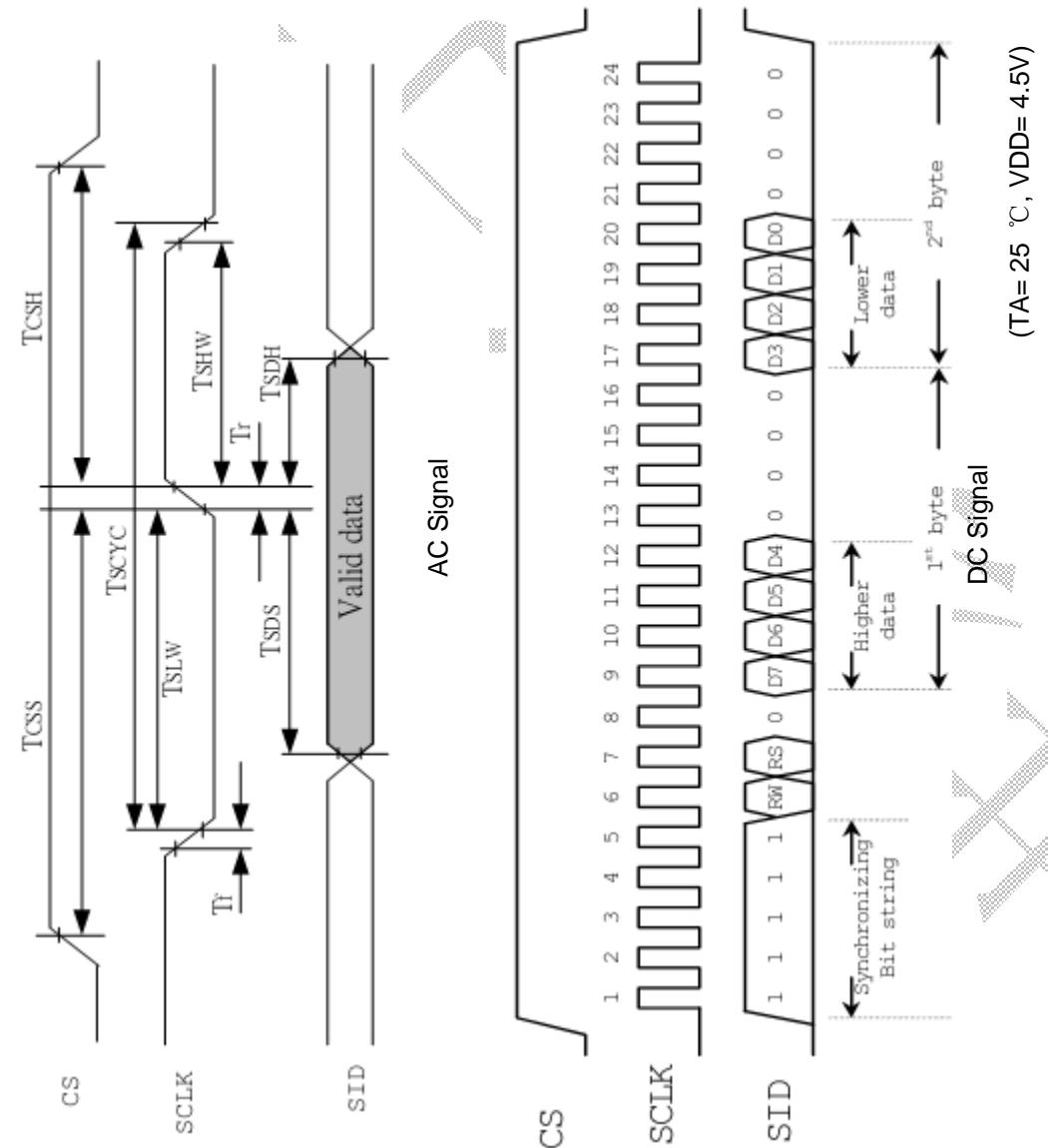
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(TA= 25 °C, VDD= 2.7V)

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<i>Internal Clock Operation</i>						
f_{osc}	OSC Frequency	R = 18KΩ	470	530	590	KHz
T_{R,T_F}	Rise/Fall Time	-	-	-	0.2	μs
<i>External Clock Operation</i>						
<i>Write Mode (Writing data from MPU to ST7920)</i>						
T_C	Enable Cycle Time	Pin E	1800	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	160	-	-	ns
T_{R,T_F}	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns
T_{AH}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns
T_{DSSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns
T_H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Read Mode (Reading Data from ST7920 to MPU)</i>						
T_C	Enable Cycle Time	Pin E	1800	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	320	-	-	ns
T_{R,T_F}	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS,RW,E	10	-	-	ns
T_{AH}	Address Hold Time	Pins: RS,RW,E	20	-	-	ns
T_{DDR}	Data Delay Time	Pins: DB0 - DB7	-	-	260	ns
T_H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Interface Mode with LCD Driver(ST7921)</i>						
T_{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns
T_{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns
T_{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns
T_{SU}	Data Setup Time	Pin: D	300	-	-	ns
T_{DH}	Data Hold Time	Pin: D	300	-	-	ns
T_{DM}	M Delay Time	Pin: M	-1000	-	1000	ns

3.32 Serial Mode Interface



Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<i>Internal Clock Operation</i>						
fosc	OSC Frequency	R = 33KΩ	470	530	590	KHz
<i>External Clock Operation</i>						
f _{Ex}	External Frequency	-	470	530	590	KHz
	Duty Cycle	-	45	50	55	%
T _{RS} T _F	Rise/Fall Time	-	-	-	0.2	μs
TSCYC	Serial clock cycle	Pin E	400	-	-	ns
TSHW	SCLK high pulse width	Pin E	200	-	-	ns
TSLW	SCLK low pulse width	Pin E	200	-	-	ns
TSDS	SID data setup time	Pins RW	40	-	-	ns
TSDH	SID data hold time	Pins RW	40	-	-	ns
TCSS	CS setup time	Pins RS	60	-	-	ns
TCSH	CS hold time	Pins RS	60	-	-	ns



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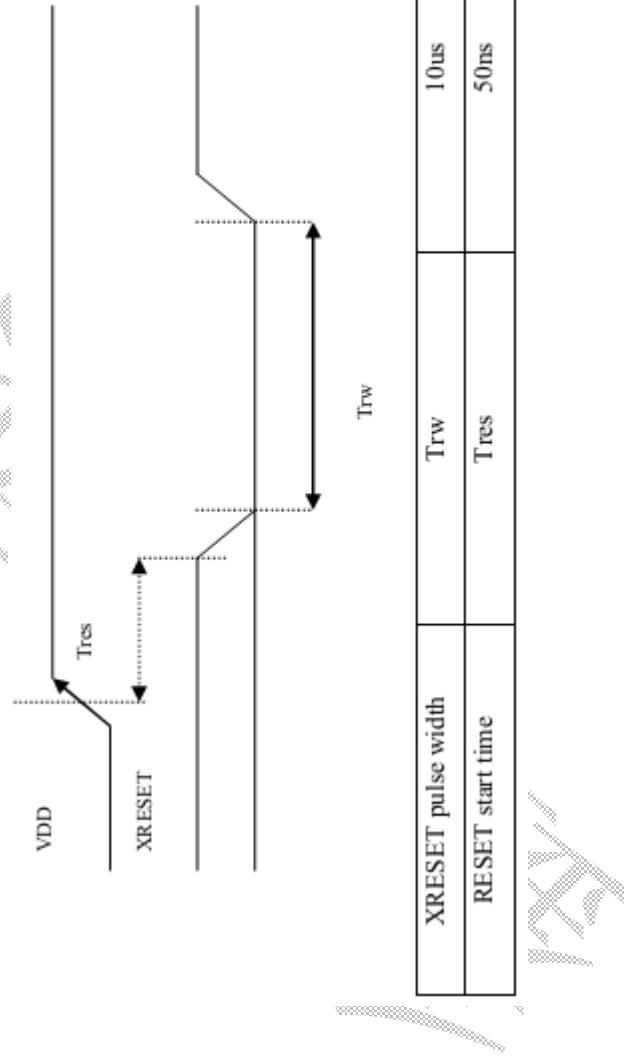
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(TA= 25 °C, VDD= 2.7V)

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Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<i>Internal Clock Operation</i>						
f_{osc}	OSC Frequency	$R = 18K\Omega$	470	530	590	KHz
<i>External Clock Operation</i>						
f_{ex}	External Frequency	-	470	530	590	KHz
	Duty Cycle	-	45	50	55	%
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μs
TSCYC	Serial clock cycle	Pin E	600	-	-	ns
TSHW	SCLK high pulse width	Pin E	300	-	-	ns
TSLW	SCLK low pulse width	Pin E	300	-	-	ns
TSDS	SID data setup time	Pins RW	40	-	-	ns
TSDH	SID data hold time	Pins RW	40	-	-	ns
TCSS	CS setup time	Pins RS	60	-	-	ns
TCSH	CS hold time	Pins RS	60	-	-	ns

3.4 Rest Timing



4. Function specifications

4.1 The Parallel Interface

Shared	6800 Mode			Serial Mode		Function(6800)
A0	R/W	E	RS(CS)	E(SCKL)	R/W(SID)	
H	H	H	-	-	-	Reads the display data
H	L	H&L	-	-	-	Writes the display data
L	H	H	-	-	-	Status read
L	L	H&L	-	-	-	Write Command data

4.2 Display Memory Map

PAGE	0x80/90			0x81/91			0x87/0x97			COL	Function(6800)
	SEG0—SEG7	SEG8—SEG15	SEG16—SEG23	SEG24—SEG31			SEG112—SEG119	SEG120—SEG127			
ROW 0	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
ROW 1	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
					Pixels:128x32						
ROW 30	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
ROW 31	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
					+ Pixels:128x32						
					0x89/0x99						
ROW 0	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
ROW 1	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
					+ Pixels:128x32						
ROW 30	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0
ROW 31	D7--D0	D7--D0	D7--D0	D7--D0	-	-	D7--D0	D7--D0	D7--D0	D7--D0	D7--D0

Note:

1nd Page: from 0x80~ 0x87 (ROW0~ ROW15)

2nd Page: from 0x90~ 0x97 (ROW16~ ROW31)

3rd Page: from 0x88~ 0x8F (ROW32~ ROW47)

4th Page: from 0x98~ 0x9F (ROW48~ ROW63)



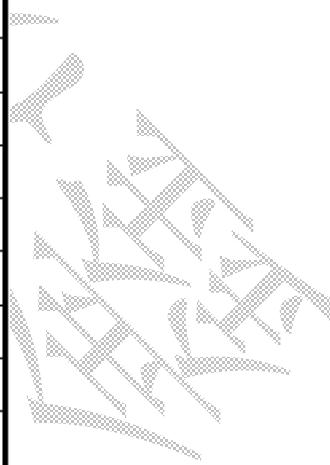
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4.3 Display Commands

Instruction Set 1: (RE=0: Basic Instruction)

Inst.	Code						Description		Exec time (540KHZ)	
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Display Clear	0	0	0	0	0	0	0	0	0	1
Return Home	0	0	0	0	0	0	0	0	1	X
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S
Display Control	0	0	0	0	0	0	1	D	C	B
Cursor Display Control	0	0	0	0	0	1	S/C	R/L	X	X
Function Set	0	0	0	1	DL	X	0	X	X	X
Set CGRAM Address.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0
Set DDRAM Address.	0	0	1	0	AC5	AC4	AC3	AC2	AC1	AC0
Read Busy Flag (BF) & AC.	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0
Write RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0
Read RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0





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Instruction set 2: (RE=1: extended instruction)

Inst.	Code								Description	
Standby	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Scroll or RAM Address. Select	0	0	0	0	0	0	0	0	0	1
Reverse (by line)	0	0	0	0	0	0	0	1	R1	R0
Extended Function Set	0	0	0	0	1	DL	X	1	G	0
Set Scroll Address	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1: AC5~AC0 the address of vertical scroll
Set Graphic Display RAM Address	0	0	1	0	0	AC3	AC2	AC1	AC0	Set GDRAM address to address counter (AC) Set the vertical address first and followed the horizontal address by consecutive writings Vertical address range: AC5...AC0 Horizontal address range: AC3...AC0

Note:

1. Make sure that ST7920 is not in busy state by reading the busy flag before sending instruction or data. If using delay loop instead, please make sure the delay time is enough. Please refer to the instruction execution time.
2. “RE” is the selection bit of basic and extended instruction set. After setting the RE bit, the value will be kept. So that the software doesn’t have to set RE every time when using the same instruction set.





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Initial Setting (Register flag) (RE=0: basic instruction)

Inst.	Code						Description		
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1 DB0
Entry Mode Set	0	0	0	0	0	0	0	1	I/D S Cursor move to right ,DDRAM address counter (AC) plus 1
Display Control	0	0	0	0	0	1	D	C B Display, cursor and blink are ALL OFF	0
CURSOR DISPLAY SHIFT	0	0	0	0	1	S/C	R/L	X X No cursor or display shift operation	0
FUNCTION SET	0	0	0	1	DL	X	0	RE X X 8-bit MPU interface , basic instruction set	0

Initial Setting (Register flag) (RE=1: extended instruction set)

Inst.	Code						Description		
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1 DB0
SCROLL OR RAM ADDR. SELECT	0	0	0	0	0	0	0	1	SR Allow vertical scroll or set CGRAM address
									0
REVERSE	0	0	0	0	0	0	1	R1 R0 Begin with normal and toggle to reverse	0 0
EXTENDED FUNCTION SET	0	0	0	1	DL	X	1	RE G 0 Graphic display OFF	0

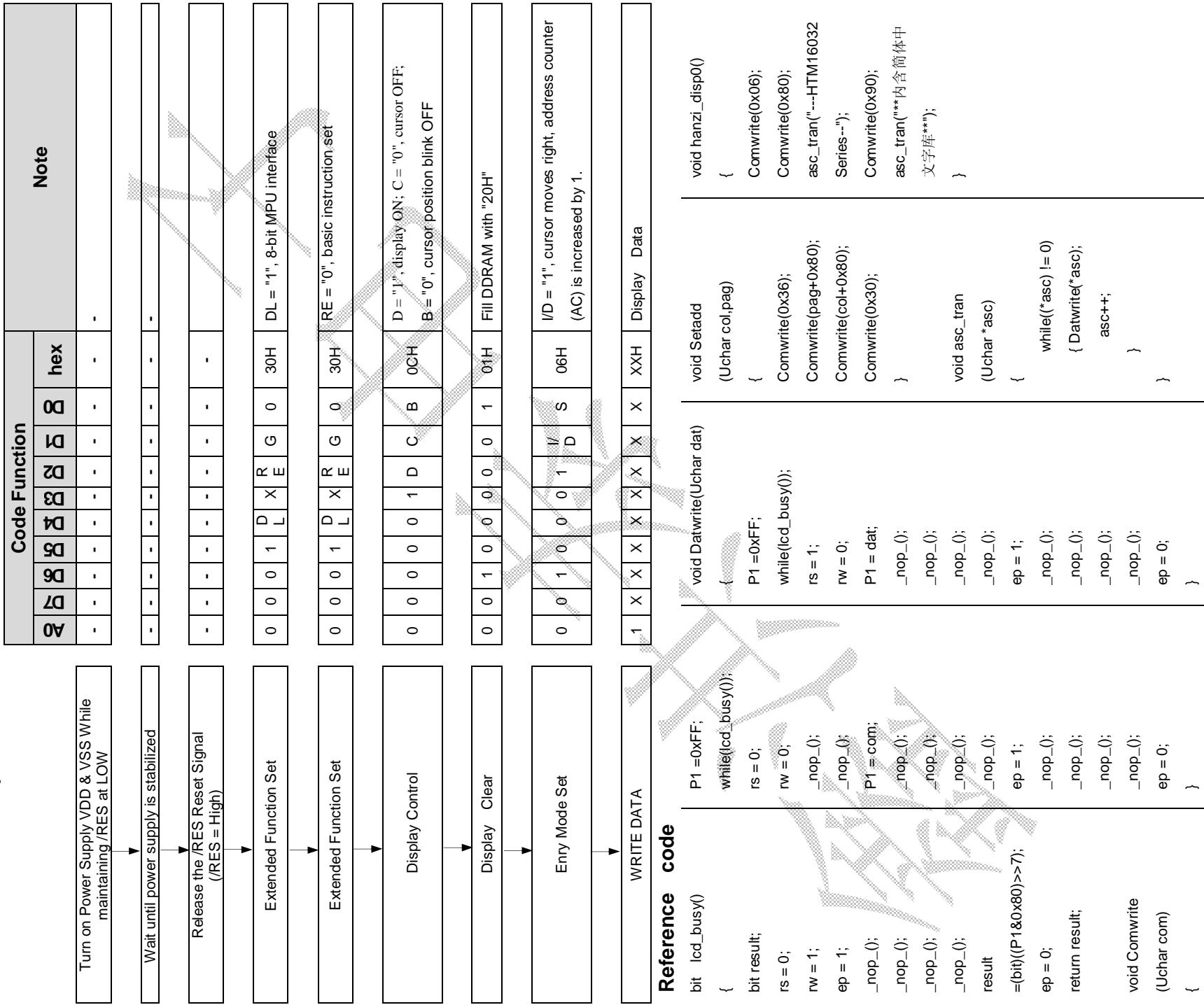




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4.4 Basic Operating Sequence Initialization Sequence

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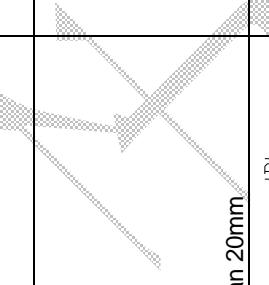
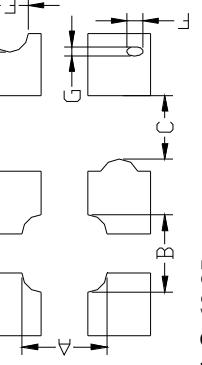




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5. Inspection Standards

Item	Criterion for defects				Defect type		
1) Display on inspection	(1) Non display (3) Horizontal line is deficient		(2) Vertical line is deficient (4) Cross line is deficient		Major		
	Size Φ (mm)		Acceptable number				
	$\Phi \leqslant 0.3$ 0.3 < $\Phi \leqslant 0.45$ 0.45 < $\Phi \leqslant 0.6$ $0.6 < \Phi$		Ignore (note) 3 1 0		Minor		
2) Black / White spot	Length (mm)	Width (mm)	Acceptable number				
	$L \leqslant 10$	$W \leqslant 0.03$	Ignore				
	$5.0 \leqslant L \leqslant 10$	$0.03 < W \leqslant 0.04$	3				
	$5.0 \leqslant L \leqslant 10$	$0.04 < W \leqslant 0.05$	2				
	$1.0 \leqslant L \leqslant 10$	$0.05 < W \leqslant 0.06$	2				
	$1.0 \leqslant L \leqslant 10$	$0.06 < W \leqslant 0.08$	1				
	$L \leqslant 10$	$0.08 < W$	follows 2) point defect				
	Defects separate with each other at an interval of more than 20mm						
3) Black / White line					Minor		
4) Display pattern					Minor		
	$\frac{A+B}{2} \leqslant 0.28$	$0 < C$	$\frac{D+E}{2} \leqslant 0.25$	$\frac{F+G}{2} \leqslant 0.25$			
	Note: 1) Up to 3 damages acceptable 2) Not allowed if there are two or more pinholes every three-fourth inch.						
5) Spot-like contrast irregularity	Size Φ (mm)	Acceptable Number					
	$\Phi \leqslant 0.7$	Ignore (note) 3					
	$0.7 < \Phi \leqslant 1.0$	1					
	$1.0 < \Phi \leqslant 1.5$	0					
	$1.5 < \Phi$						
	Note: 1) Conformed to limit samples. 2) Intervals of defects are more than 30mm.						
6) Bubbles in polarizer	Size Φ (mm)	Acceptable Number					
	$\Phi \leqslant 0.4$	Ignore (note) 2					
	$0.4 < \Phi \leqslant 0.65$	1					
	$0.65 < \Phi \leqslant 1.2$	0					
	$1.2 < \Phi$						
7) Scratches and dent on the polarizer	Scratches and dent on the polarizer shall be in the accordance with "2)"				Minor		
8) Stains on the surface of LCD panel	Stains which cannot be removed even when wiped lightly with a soft cloth or similar cleaning.				Minor		
9) Rainbow color	No rainbow color is allowed in the optimum contrast on state within the active area.						
10) Viewing area encroachment	Polarizer edge or line is visible in the opening viewing area due to polarizer shortness or sealing line.						
11) Bezel appearance	Rust and deep damages that are visible in the bezel are rejected.						
12) Defect of land surface contact	Evident crevices that are visible are rejected.				Minor		
13) Parts mounting	(1) Failure to mount parts (2) Parts not in the specifications are mounted (3) For example: Polarity is reversed, HSC or TCP falls off.				Minor		
14) Part alignment	(1) LSI, IC lead width is more than 50% beyond pad outline. (2) More than 50% of LSI, IC leads is off the pad outline.				Minor		
15) Conductive foreign matter (solder ball, solder hips)	(1) $0.45 < \Phi, N \geqslant 1$ (2) $0.3 < \Phi \leqslant 0.45, N \geqslant 1, \Phi$: Average diameter of solder ball (unit: mm) (3) $0.5 < L, N \geqslant 1, L$: Average length of solder chip (unit: mm)				Minor		
16) Bezel flaw	Bezel claw missing or not bent				Minor		
17) Indication on name plate (sampling indication label)	(1) Failure to stamp or label error, or not legible.(all acceptable if legible) (2) The separation is more than 1/3 for indication discoloration, in which the characters can be checked.				Minor		



6. Handling Precautions

6.1 Mounting method

A panel of LCD module made by our company consists of two thin glass plates with polarizers that easily get damaged. And since the module is so constructed as to be fixed by utilizing fitting holes in the printed circuit board (PCB), extreme care should be used when handling the LCD modules.

6.2 Cautions of LCD handling and cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
 - Ethyl alcohol
 - Trichlorotrifluoroethane
- Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.
- Do not use the following solvent:
- Water
 - Ketene
 - Aromatics

6.3 Caution against static charge

The LCD module use C-MOS LSI drivers. So we recommend you:

Connect any unused input terminal to V_{dd} or V_{ss} . Do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

6.4 Packaging

-Module employs LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
-To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

6.5 Caution for operation

-It is an indispensable condition to drive LCD module within the limits of the specified voltage since the higher voltage over the limits may cause the shorter life of LCD module.
-An electrochemical reaction due to DC (direct current) causes LCD undesirable deterioration so that the uses of DC (direct current) drive should be avoided.
-Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD module may show dark color in them. However those phenomena do not mean malfunction or out of order of LCD module, which will come back in the specified operating temperature.

6.6 Storage

In the case of storing for a long period of time, the following ways are recommended:

- Storage in polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with not desiccant.
 - Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping the storage temperature range.
 - Storing with no touch on polarizer surface by any thing else.
- It is recommendable to crash damaged or unnecessary LCD into pieces and to wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well at once with soap and water.

6.7 Safety

7. Packaging Specifications

 霍士 HOT DISPLAY		Packaging Specifications	
		Approved	Canceled
		Beta tested	

HTM12864Z

7.1 Packaging Material

No	Item	Dimensions (mm)	IPCS Weight (KG)	Quantity	Total Weight
1	LCM	93.0*70.0*9.1	0.075	112	9.6
2	PE Bag	125*100	0.001	112	0.11
3	Foam Rubber Cushion	310*170	0.0175	8	1.8
4	Partition A1	310*170*100	0.30	4	1.2
5	Product Box	330*180*120(neutral packing)	0.45	4	1.8
6	Carton	390*370*350(neutral packing)	0.9	1	0.9
7	Tape			AR	
8	Label Specifications			1	
9	Label Rohs			1	
10	Label ESD			1	

7.2. Total LCD Weight in carton: 15.0 KG ± 10%

7.3. Packaging Specifications and Quantity:

(1) Quantity Of Spacer:A2*6

(2) Total LCM quantity in carton: quantity per box 28* no of boxes 4 = 112

